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(54) **INK JET HEAD AND IMAGE FORMING APPARATUS**

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(57) **ABSTRACT**

An ink jet head comprises a substrate including a mounting surface and a pressure chamber open to the mounting surface. The ink jet head further comprises a nozzle plate including an inner surface fixed to the mounting surface and covering the pressure chamber, a nozzle open to the pressure chamber, and a piezoelectric element surrounding the nozzle and configured to deform to thereby change a volume of the pressure chamber. The ink jet head further comprises a deformation control unit disposed on and extending from the inner surface of the nozzle plate and surrounding the nozzle, the deformation control unit configured to cause deformation of the piezoelectric element to be substantially symmetric with respect to the nozzle.

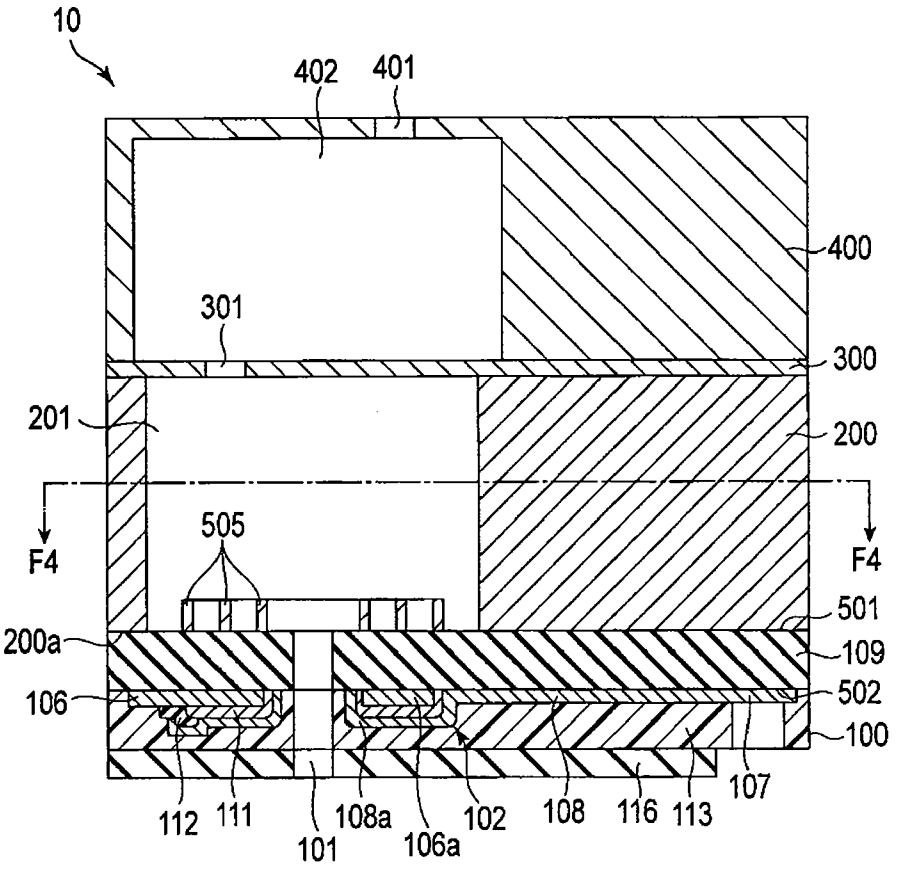


FIG. 1

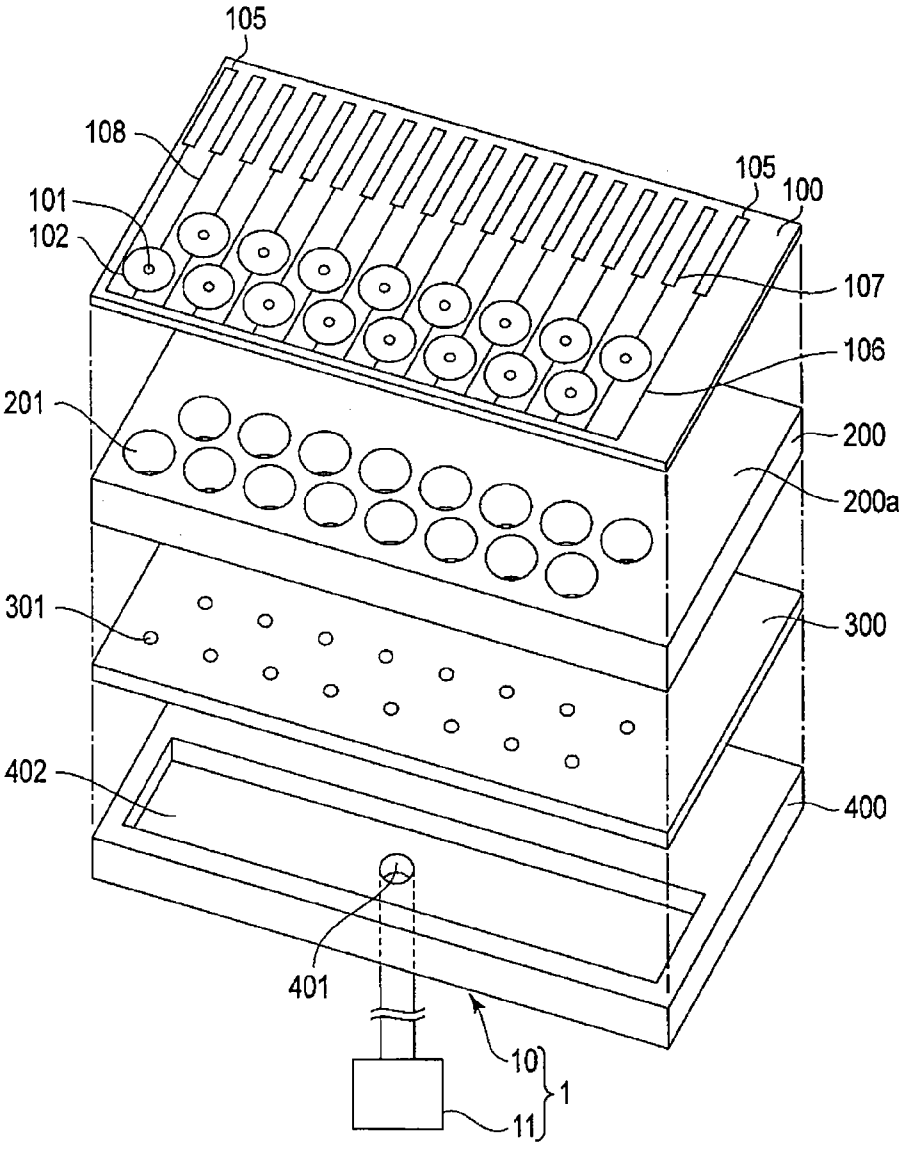

105
108
101
102
105
100
107
106
201
200
200a
301
300
402
400
401
10
1
11

FIG. 2

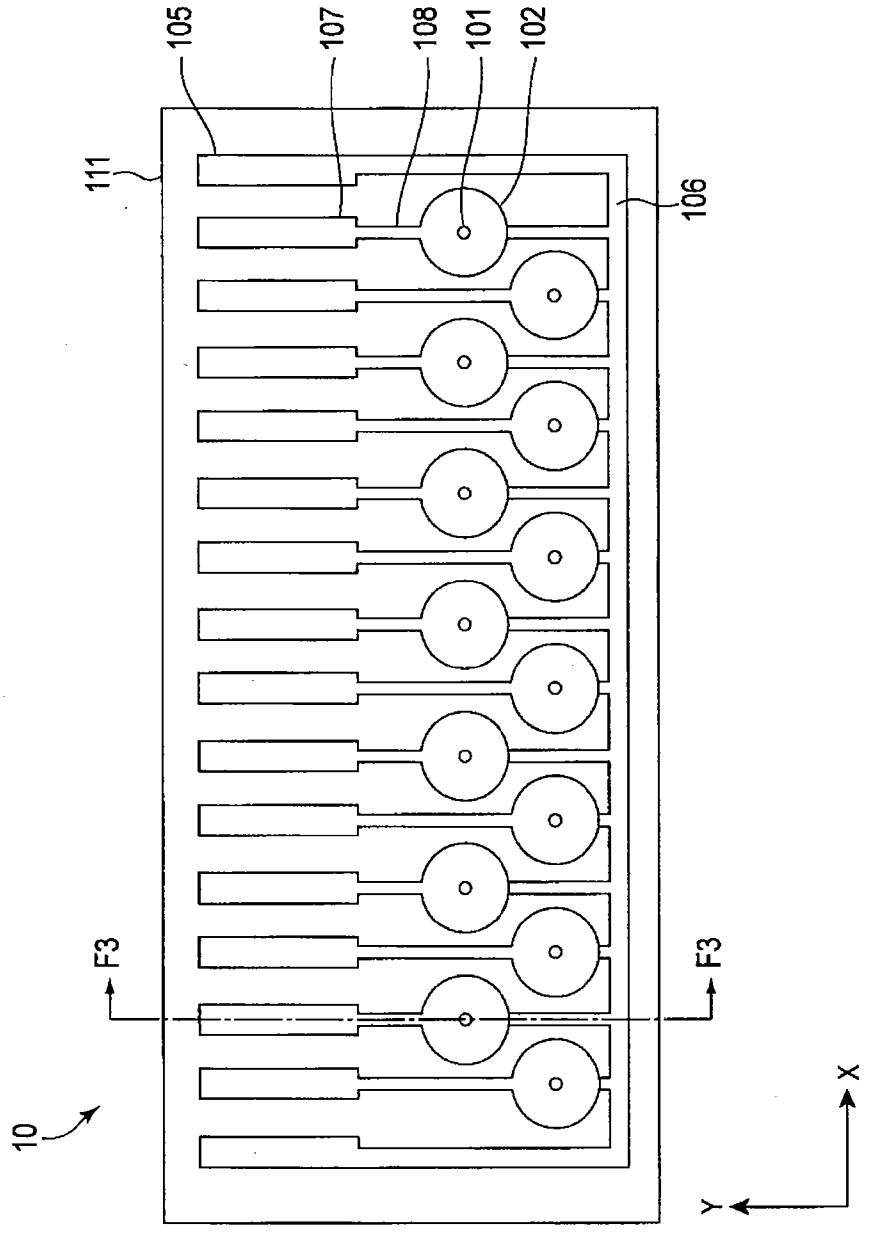


FIG. 3

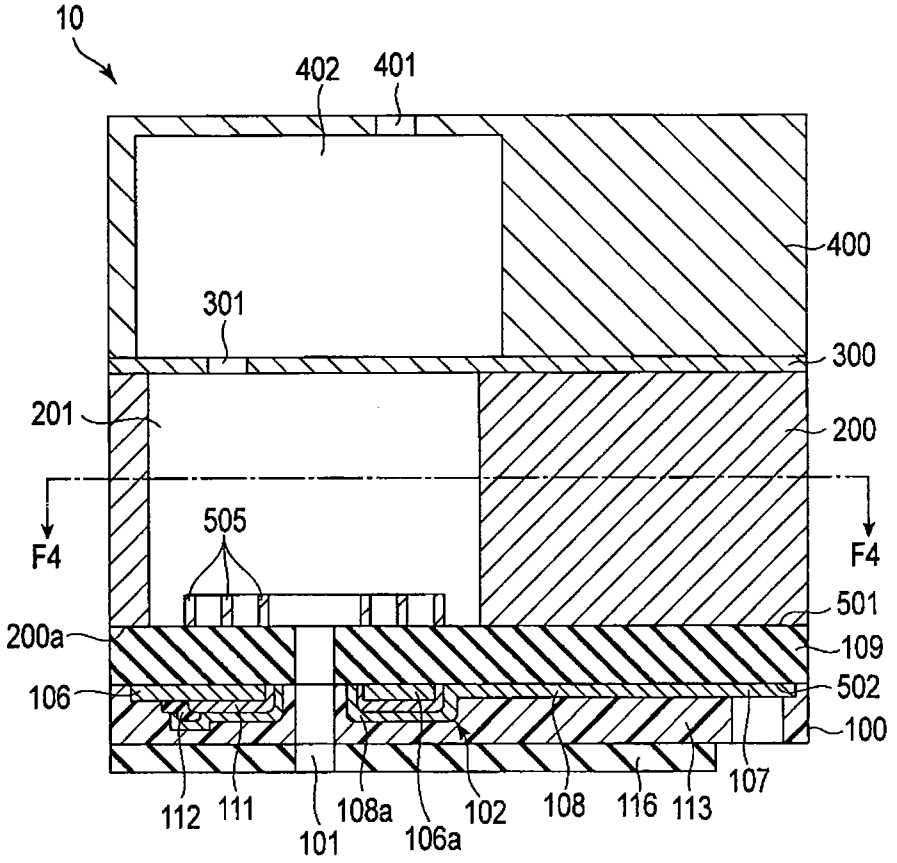

10
402
401
400
301
300
201
200
505
F4
F4
501
200a
109
106
502
100
112
111
101
108a
106a
102
108
116
113
107

FIG. 4

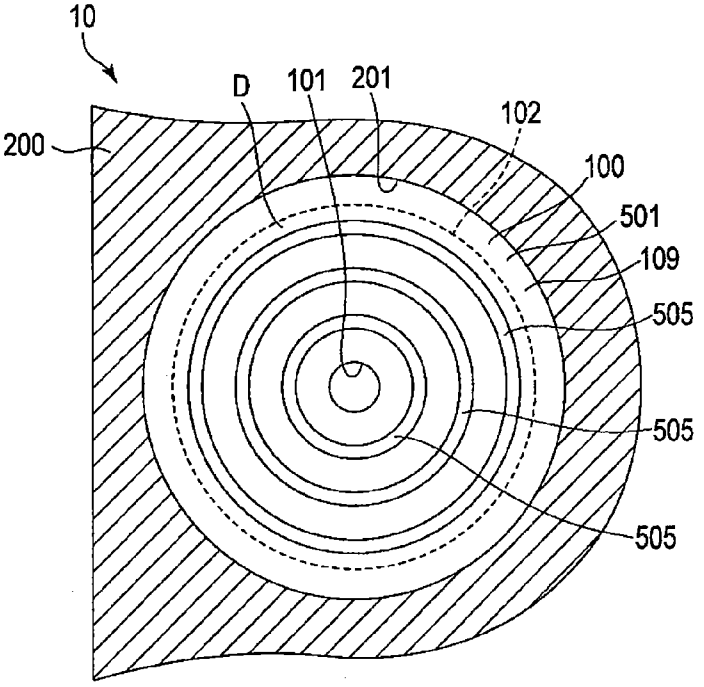

10
D
101
201
102
200
100
501
109
505
505
505

FIG. 5

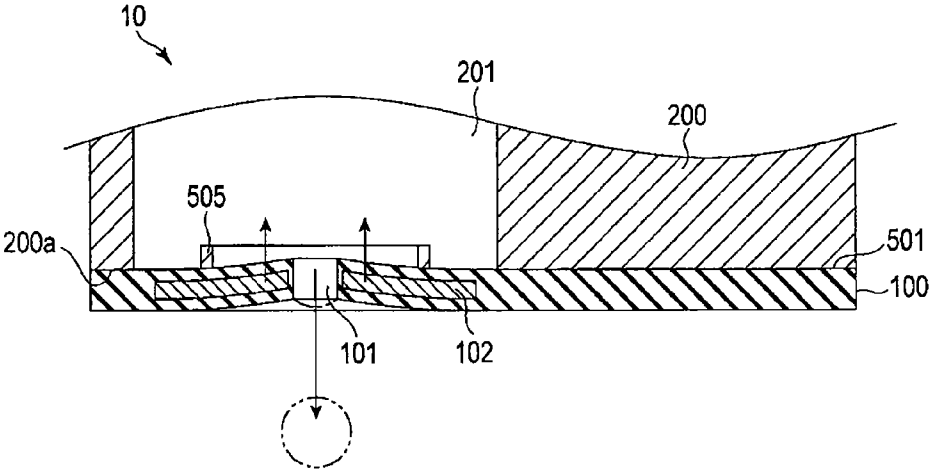

10
201
200
505
200a
501
100
101
102

FIG. 6

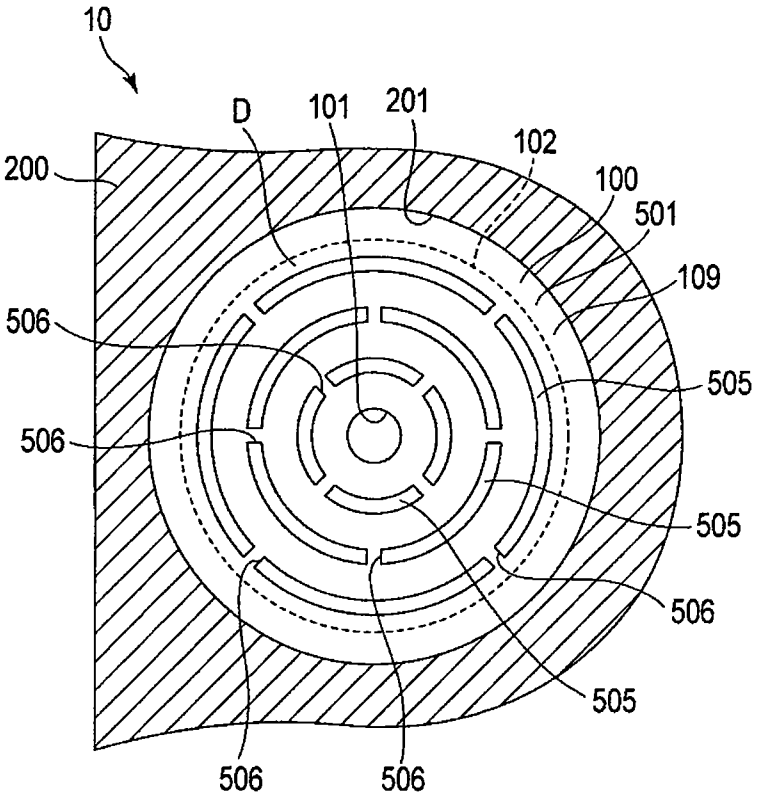


FIG. 7

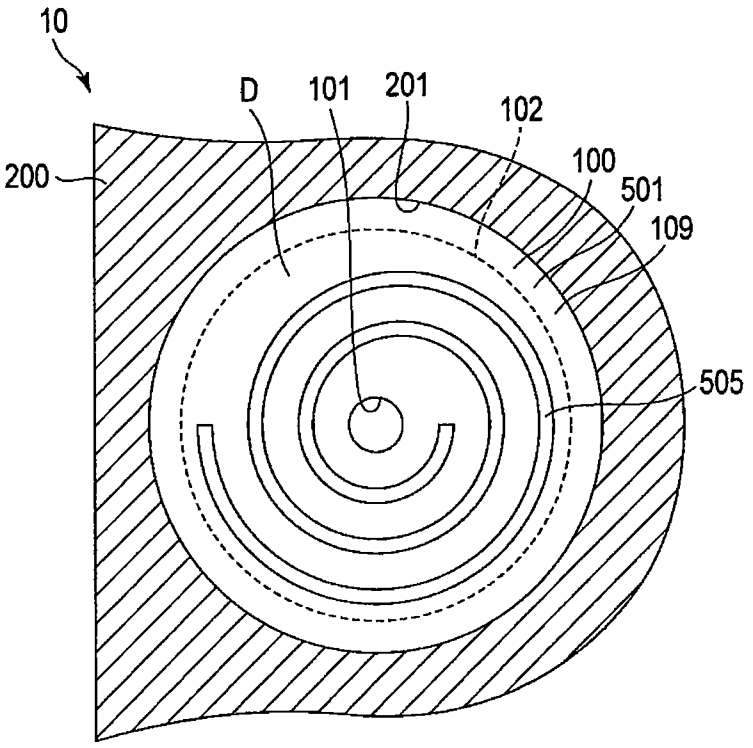


FIG. 8

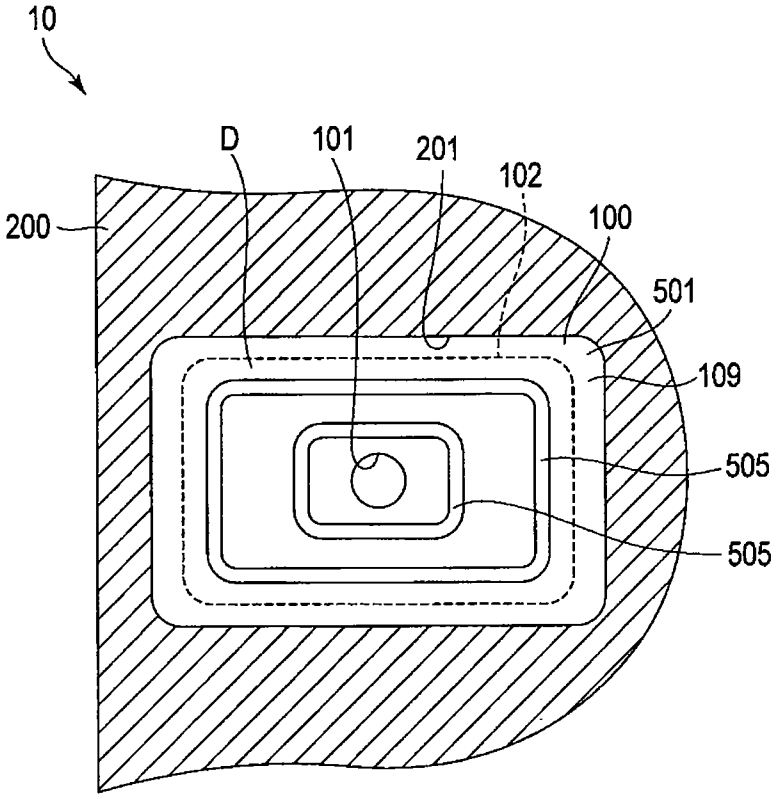
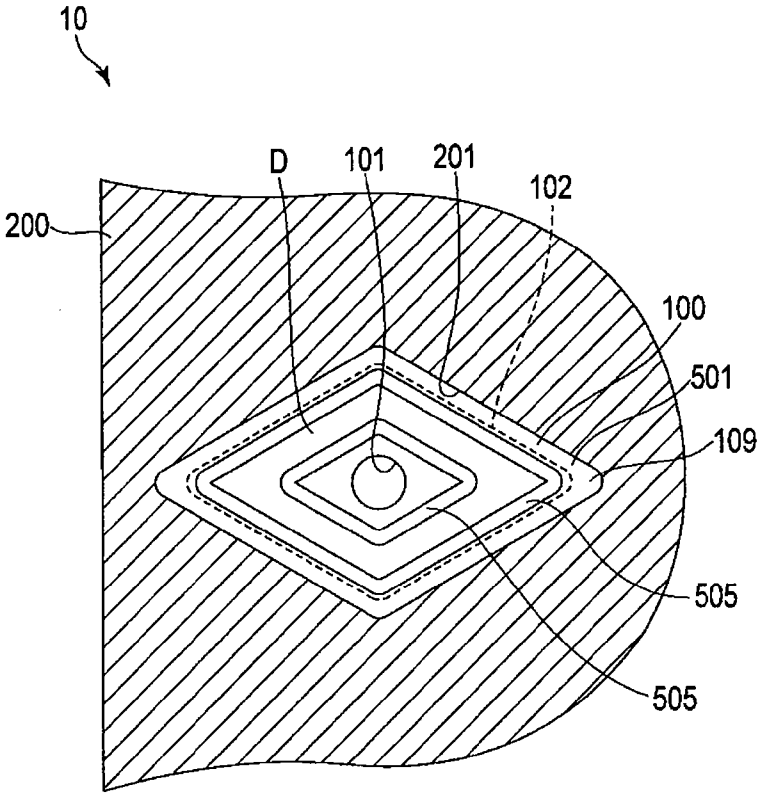


FIG. 9



INK JET HEAD AND IMAGE FORMING APPARATUS

CROSS-REFERENCE TO RELATED APPLICATION

[0001] This application is based upon and claims the benefit of priority from Japanese Patent Application No. 2012-192550; filed on Aug. 31, 2012, the entire contents of which are incorporated herein by reference.

FIELD

[0002] Embodiments described herein relate generally to an ink jet head and an image forming device.

BACKGROUND

[0003] On-demand type ink jet recording methods are known in which discharge ink droplets are discharged from a nozzle according to an image signal to form an image on a recording paper. In connection with the on-demand type ink jet recording method, a heating element type ink jet recording method and a piezoelectric element type ink jet recording method are known.

[0004] In the heating element type ink jet recording method, air bubbles are generated in ink by heat provided by a heat source in an ink flow channel. The ink pressed by the air bubbles is discharged from a nozzle.

[0005] In the piezoelectric element type ink jet recording method, a pressure change occurs in an ink chamber, where ink is stored, due to the deformation of a piezoelectric element. Thus the ink is discharged from a nozzle.

[0006] A piezoelectric element is an electromechanical conversion element, undergoes expansion or shear deformation when an electric field is applied thereto. Lead zirconate titanate is used as a representative piezoelectric element.

[0007] With respect to an ink jet head using a piezoelectric element, a configuration using a nozzle plate formed of a piezoelectric material is known. The nozzle plate of the ink jet head includes an actuator. The actuator includes, for example, a piezoelectric film having a nozzle for discharging ink, and a metal electrode film formed on both surfaces of the piezoelectric film surrounding the nozzle.

[0008] The ink jet head includes a pressure chamber that is connected to the nozzle. Ink enters the pressure chamber and the nozzle of the nozzle plate and forms a meniscus within the nozzle, and thus the ink is maintained within the nozzle. When a driving waveform (voltage) is applied to the two electrodes provided around the nozzle on either side of the piezoelectric film, an electric field in the same direction as a polarization direction is applied to the piezoelectric film through the electrodes. Thereby, the actuator expands and contracts in a direction perpendicular to the direction of the electric field. The nozzle plate deforms by virtue of the expansion and the contraction of the actuator. A pressure change occurs in the ink within the pressure chamber due to the deformation of the nozzle plate, and thus the ink within the nozzle is discharged.

[0009] When a nozzle plate is formed, film stress occurs. There is a concern that a uniform deformation of the nozzle plate through an actuator may be obstructed by the film stress of the nozzle plate. When the deformation of the nozzle plate becomes non-uniform, there is a concern that a discharge direction of ink may become unstable.

DESCRIPTION OF THE DRAWINGS

[0010] FIG. **1** is an exploded perspective view of an ink jet head of an ink jet printer, according to a first embodiment.

[0011] FIG. **2** is a plane view of the ink jet head according to the first embodiment.

[0012] FIG. **3** is a cross-sectional view of the ink jet head of the first embodiment taken along line F**3**-F**3** of FIG. **2**.

[0013] FIG. **4** is a cross-sectional view of a part of the ink jet head of the first embodiment taken along line F**4**-F**4** of FIG. **3**.

[0014] FIG. **5** is a cross-sectional view of a part of an ink jet head of the first embodiment in which a nozzle plate is deformed.

[0015] FIG. **6** is a cross-sectional view of a part of an ink jet head according to a second embodiment.

[0016] FIG. **7** is a cross-sectional view of a part of an ink jet head according to a third embodiment.

[0017] FIG. **8** is a cross-sectional view of a part of an ink jet head according to a fourth embodiment.

[0018] FIG. **9** is a cross-sectional view of a part of an ink jet head according to a fifth embodiment.

DETAILED DESCRIPTION

[0019] An ink jet head according to an embodiment comprises a substrate including amounting surface and a pressure chamber open to the mounting surface. The ink jet head further comprises a nozzle plate including an inner surface fixed to the mounting surface and covering the pressure chamber, a nozzle open to the pressure chamber, and a piezoelectric element surrounding the nozzle and configured to deform to thereby change a volume of the pressure chamber. The ink jet head further comprises a deformation control unit disposed on and extending from the inner surface of the nozzle plate and surrounding the nozzle, the deformation control unit configured to cause deformation of the piezoelectric element to be substantially symmetric with respect to the nozzle.

[0020] Hereinafter, a first embodiment will be described with reference to FIG. **1** through FIG. **5**.

[0021] FIG. **1** is an exploded perspective view of an ink jet head **10** of an ink jet printer **1** according to a first embodiment. FIG. **2** is a plane view of the ink jet head **10**. FIG. **3** is a schematic cross-sectional view of the ink jet head **10** taken along line F**3**-F**3** of FIG. **2**.

[0022] As shown in FIG. **1**, the ink jet head **10** is mounted on the ink jet printer **1**. The ink jet printer **1** is an example of an image forming device. The image forming device is not limited thereto, and may be any other image forming device such as a copy machine.

[0023] The ink jet head **10** includes a nozzle plate **100**, a pressure chamber structure **200**, a separate plate **300**, and an ink feed passage structure **400**. The pressure chamber structure **200** can be formed from a substrate. The pressure chamber structure **200**, the separate plate **300**, and the ink feed passage structure **400** are joined with, for example, an epoxy-based adhesive.

[0024] The nozzle plate **100** is formed in a rectangular plate shape. The nozzle plate **100** is formed on the pressure chamber structure **200** by using a film-forming process, described below. As a result of the film-forming process, the nozzle plate **100** is firmly fixed to the pressure chamber structure **200**.

[0025] A plurality of nozzles **101** for discharging ink are provided in the nozzle plate **100**. Each nozzle **101** is a circular hole that extends through the nozzle plate **100** in the thickness direction.

[0026] The pressure chamber structure **200** is formed of a silicon wafer having a rectangular plate shape. The thickness of the pressure chamber structure **200** is, for example, 725 Heating and thin-film formation are repeatedly performed on the pressure chamber structure **200** during a manufacturing process of the ink jet head **10**. For this reason, the silicon wafer has a heat resistance property and is smoothed according to an SEMI (Semiconductor Equipment and Materials International) standard. However, the pressure chamber structure **200** is not limited to the above description, and may be formed of any of other semiconductors such as a silicon carbide (SiC) germanium substrate.

[0027] The pressure chamber structure **200** includes a mounting surface **200***a* that faces the nozzle plate **100**, and a plurality of pressure chambers **201**. The nozzle plate **100** is firmly fixed to the mounting surface **200***a*.

[0028] The pressure chamber **201** is comprised of a circular hole, for example having a diameter of 240 μm. However, the pressure chamber **201** may be a hole having any of other shapes such as a rectangular shape or a rhombic shape. The pressure chambers **201** open on the mounting surface **200***a* and are covered by the nozzle plate **100**.

[0029] The plurality of pressure chambers **201** are arranged to correspond to the plurality of nozzles **101**, and are disposed coaxially with the plurality of nozzles **101**, respectively. For this reason, each nozzle **101** is in direct communication with a corresponding pressure chamber **201**.

[0030] The separate plate **300** is formed of stainless steel having a rectangular plate shape. The separate plate **300** covers the plurality of pressure chambers **201** on the side opposite of the nozzle plate **100**.

[0031] A plurality of ink apertures **301** are provided in the separate plate **300**. Each of the plurality of ink apertures **301** are disposed so as to respectively correspond to one of the pressure chambers **201**. For this reason, each ink aperture **301** opens in one of the pressure chambers **201**. The ink apertures **301** are formed such that the ink flow path resistance to each of the respective pressure chambers **201** is approximately the same.

[0032] The ink feed passage structure **400** is formed of stainless steel having a rectangular plate shape. The ink feed passage structure **400** includes an ink supply port **401** and an ink supply passage **402**.

[0033] The ink supply port **401** is disposed in a central portion of the ink supply passage **402**. The ink supply port **401** is connected to an ink tank **11** in which ink for forming an image is stored. The ink tank **11** supplies the ink to the ink supply passage **402**.

[0034] The ink supply passage **402** is recessed from the surface of the ink feed passage structure **400**, and extends outwardly beyond the perimeter of the array of ink apertures **301**. In other words, each of the ink apertures **301** open into the ink supply passage **402**. Thus, the ink supply port **401** supplies ink to all the pressure chambers **201** through the ink apertures **301**. In addition, the ink supply port **401** is formed such that the ink flow path resistance to each of the respective pressure chambers **201** is approximately the same.

[0035] As described above, the separate plate **300** and the ink feed passage structures **400** may be formed of stainless steel. However, the materials of such components are not limited to stainless steel. The separate plate **300** and the ink feed passage structure **400** may be formed of any of other materials such as a ceramic, a resin, or a metal alloy so long as a difference in expansion coefficient between the separate plate **300** and the ink feed passage structure **400** on the one hand, and the nozzle plate **100**, on the other hand does not affect the generation of ink discharge pressure. The ceramic used may be a nitride or an oxide such as alumina ceramic, zirconia, silicon carbide, silicon nitride, or barium titanate. The resin used may be a plastic material such as ABS (acrylonitrile•butadiene•styrene), polyacetal, polyamide, polycarbonate, or polyethersulfone. The metal used may be, for example, aluminum or titanium.

[0036] The pressure chamber **201** holds the supplied ink. When a pressure change occurs in the ink within each pressure chamber **201** by the deformation of the nozzle plate **100**, the ink within the pressure chamber **201** is discharged from each nozzle **101**. The separate plate **300** confines pressure generated within the pressure chambers **201** so as to prevent the pressure from escaping to the ink supply passage **402**. For this reason, the diameter of the ink aperture **301** is, for example, equal to or less than ¼ of the diameter of the pressure chamber **201**.

[0037] Next, the nozzle plate **100** will be described. As shown in FIG. **2**, the nozzle plate **100** includes the above-mentioned plurality of nozzles **101**, a plurality of actuators **102**, two shared electrode terminal portions **105**, a shared electrode **106**, a plurality of wiring electrode terminal portions **107**, and a plurality of wiring electrodes **108**. As shown in FIG. **3**, the nozzle plate **100** further includes a vibration plate **109**, a protective film **113**, and an ink-repellent film **116**. The actuator **102** is an example of a piezoelectric element.

[0038] The vibration plate **109** has a rectangular shape and is formed on the mounting surface **200***a* of the pressure chamber structure **200**. The vibration plate **109** includes a first surface **501** and a second surface **502**. The first surface **501** is an example of an inner surface of the nozzle plate.

[0039] The first surface **501** is firmly fixed to the mounting surface **200***a* of the pressure chamber **200** and covers the pressure chambers **201**, except in the location of the nozzle **101** extending therethrough. The second surface **502** is located on the opposite side of the first surface **501**. The actuators **102**, the shared electrode **106**, and the wiring electrodes **108** are formed on the second surface **502** of the vibration plate **109**.

[0040] The plurality of actuators **102** are arranged so that each corresponds to one of the plurality of pressure chambers **201** and one of the plurality of nozzles **101**. The actuator **102** generates pressure for discharging ink in the pressure chamber **201** from the nozzle **101**.

[0041] As shown in FIG. **2**, the actuator **102** is formed in an annular shape. The actuator **102** is disposed coaxially with the corresponding nozzle **101**. In other words, the center of the actuator **102** and the center of the nozzle **101** are aligned. The actuator **102** surrounds the nozzle **101**. However, the center of the actuator **102** and the center of the nozzle **101** may deviate from each other.

[0042] In order to arrange the nozzles **101** with higher density, the nozzles **101** are disposed in a zigzag shape. In other words, the plurality of nozzles **101** are arranged linearly in an X-axis direction of FIG. **2**. Two aligned rows of the nozzles **101** are provided in a Y-axis direction.

[0043] As shown in FIG. **3**, the actuator **102** includes a piezoelectric film **111**, an electrode portion **106***a* of the shared

electrode **106**, an electrode portion **108***a* of the wiring electrode **108**, and an insulating film **112**.

[0044] The piezoelectric film **111** may be formed of lead zirconate titanate (PZT) in a film shape. The piezoelectric film **111** is not limited to that material, and may be formed of any of various materials such as PTO ($PbTiO_3$: lead titanate), PMNT ($Pb(Mg_{1/3}Nb_{2/3})O_3$—$PbTiO_3$), PZNT ($Pb(Zn_{1/3}Nb_{2/3})O_3$—$PbTiO_3$), ZnO, and AlN.

[0045] The piezoelectric film **111** is formed in an annular shape. The piezoelectric film **111** is disposed coaxially with the nozzle **101** and the pressure chamber **201**. In other words, the piezoelectric film **111** surrounds the nozzle **101**. An inner circumferential portion of the piezoelectric film **111** is slightly separated from the nozzle **101**.

[0046] The piezoelectric film **111** is sandwiched between the electrode portion **108***a* of the wiring electrode **108** and the electrode portion **106***a* of the shared electrode **106**. In other words, the electrode portion **108***a* of the wiring electrode **108** and the electrode portion **106***a* of the shared electrode **106** are disposed on either side of the piezoelectric film **111**.

[0047] The formed piezoelectric film **111** generates polarization in the thickness direction. When an electric field is applied to the piezoelectric film **111** in the same direction as the polarization direction through the wiring electrode **108** and the shared electrode **106**, the actuator **102** expands and contracts in a direction perpendicular to the direction of the electric field. The vibration plate **109** is deformed in the thickness direction of the nozzle plate **100** by the expansion and the contraction of the actuator **102**. The capacity of the pressure chamber **201** is changed, and a pressure change occurs in the ink within the pressure chamber **201**.

[0048] The electrode portion **108***a* of the wiring electrode **108** is one of two electrodes connected to the opposed sides of the piezoelectric film **111**. The electrode portion **108***a* of the wiring electrode **108** is formed in an annular shape larger than that of the piezoelectric film **111**, and is formed on the discharge side (the side facing the outside of the ink jet head **10**) of the piezoelectric film **111**.

[0049] The electrode portion **106***a* of the shared electrode **106** is one of the two electrodes connected to the piezoelectric film **111**. The electrode portion **106***a* of the shared electrode **106** is formed in an annular shape smaller than that of the piezoelectric film **111**, and is formed on the second surface **502** of the vibration plate **109**. The electrode portion **106***a* of the shared electrode **106** is formed on the second surface **502** of the vibration plate **109**.

[0050] The insulating film **112** is sandwiched between the shared electrode **106** and the wiring electrode **108** on the outside of a region in which the piezoelectric film **111** is formed. That is, the shared electrode **106** and the wiring electrode **108** are insulated from each other by the piezoelectric film **111** or the insulating film **112**. The insulating film **112** may be formed of, for example, SiO_2 (silicon oxide). The insulating film **112** may be formed of any of other materials.

[0051] A driving circuit is connected to the shared electrode terminal portions **105** and the wiring electrode terminal portions **107**. The driving circuit may be, for example, a flexible printed circuit board or a tape carrier package (TCP).

[0052] The wiring electrode terminal portion **107** is provided at an end of the wiring electrode **108**. The wiring electrode terminal portion **107** is connected to the driving circuit and transmits a signal for driving the actuator **102**.

[0053] As shown in FIG. **2**, an interval between the wiring electrode terminal portions **107** is the same as an interval between the nozzles **101** in the X-axis direction. The width of the wiring electrode terminal portion **107** in the X-axis direction is wider than the width of the wiring electrode **108**. For this reason, the wiring electrode terminal portion **107** is easily connected to the driving circuit.

[0054] For example, the shared electrode terminal portions **105** are provided on the second surface **502** of the vibration plate **109**. The shared electrode terminal portion **105** is an end of the shared electrode **106** and is connected to a GND (ground=0 V) provided in the driving circuit.

[0055] The wiring electrodes **108** are each individually connected to the piezoelectric films **111** of the corresponding actuators **102** and each transmit a signal for driving the respective actuators **102**. Each wiring electrode **108** is used as an individual electrode for operating the piezoelectric film **111** independently of other piezoelectric films **111** on the nozzle plate **100**. Each of the plurality of wiring electrodes **108** includes the above-mentioned electrode portion **108***a*, a wiring portion, and the above-mentioned wiring electrode terminal portion **107**.

[0056] The wiring portion of the wiring electrode **108** extends toward the wiring electrode terminal portion **107** from the electrode portion **108***a*. The electrode portion **108***a* of the wiring electrode **108** is disposed coaxially with the nozzle **101**. An inner circumferential portion of the electrode portion **108***a* is slightly separated from the nozzle **101**.

[0057] The wiring electrodes **108** are formed of, for example, a Pt (platinum) thin film. However, the wiring electrodes **108** may be formed of any of other materials such as Ni (nickel), Cu (copper), Al (aluminum), Ag (silver), Ti (titanium), W (tantalum), No (molybdenum), or Au (gold).

[0058] The shared electrode **106** is connected to the plurality of piezoelectric films **111**. The shared electrode **106** includes the above-mentioned plurality of electrode portions **106***a*, a plurality of wiring portions, and the above-mentioned two shared electrode terminal portions **105**.

[0059] The wiring portion of the shared electrode **106** extends from the electrode portion **106***a* to the opposite side of the wiring portion of the wiring electrode **108**. The wiring portions of the shared electrode **106** join at an end of the nozzle plate **100** in the Y-axis direction shown in FIG. **2**, and extend to both ends of the nozzle plate **100** in the X-axis direction. The electrode portion **106***a* is provided coaxially around the nozzle **101**. An inner circumferential portion of the electrode portion **106***a* is spaced separated from the outer circumference of nozzle **101**. The shared electrode terminal portions **105** are respectively disposed at opposed ends of the nozzle plate **100** in the X-axis direction.

[0060] The shared electrode **106** may be formed of, for example, a Pt (platinum)/Ti (titanium) thin film. However, the shared electrode **106** may be formed of any of other materials such as Ni, Cu, Al, Ti, W, Mo, or Au.

[0061] As shown in FIG. **3**, the protective film **113** is provided on the second surface **502** of the vibration plate **109**. The protective film **113** covers the second surface **502** of the vibration plate **109**, the shared electrode **106**, the wiring electrode **108**, and the piezoelectric film **111**.

[0062] The protective film **113** may be formed of polyimide. The protective film **113** is not limited thereto, and may be formed of any of other materials such as a resin, a ceramic, or a metal (alloy). The resin used is a plastic material such as ABS (acrylonitrile•butadiene•styrene), polyacetal, polyamide, polycarbonate, or polyethersulfone. The ceramic used is a nitride or an oxide such as zirconia, silicon carbide,

silicon nitride, or barium titanate. The metal used is, for example, aluminum, SUS, or titanium. Meanwhile, when the protective film **113** is formed of a conductive material, the shared electrode **106**, the wiring electrode **108**, and the piezoelectric film **111** are insulated from each other, for example, by a resin.

[0063] The material of the protective film **113** has a Young's modulus that is greatly different from that of the material of the vibration plate **109**. A deformation amount of a plate shape is affected by the Young's modulus and a plate thickness of a material. Even when the same force is applied, the deformation amount increases as the Young's modulus decreases and the plate thickness decreases.

[0064] The ink-repellent film **116** covers the surface of the protective film **113**. The ink-repellent film **116** may be formed of a silicone-based water repellent material with a water repellent property. However, the ink-repellent film **116** may be formed of any of other materials such as a fluoride-containing organic material.

[0065] The ink-repellent film **116** does not cover the shared electrode terminal portions **105**, the wiring electrode terminal portions **107**, and the protective film **113** around the shared electrode terminal portions **105** and the wiring electrode terminal portions **107**, so as to expose such components.

[0066] The nozzles **101** extend through the vibration plate **109**, the protective film **113**, and the ink-repellent film **116**. In other words, the nozzles **101** are provided in the vibration plate **109**, the protective film **113**, and the ink-repellent film **116**.

[0067] The vibration plate **109** may be formed of SiO_2. However, the vibration plate **109** is not limited thereto, and may be formed of any of other materials such as SiN (silicon nitride), Al_2O_3 (aluminum oxide), HfO_2 (hafnium oxide), ZrO_2 (zirconium oxide), or DLC (Diamond Like Carbon).

[0068] The material of the vibration plate **109** is selected in consideration of, for example, a heat resistance property, an insulation property (e.g., when ink with high conductivity is used, the influence of ink alteration due to the driving of the actuator **102** is considered), an expansion coefficient, smoothness, and wettability with respect to ink.

[0069] As shown in FIG. **3**, a plurality of deformation control units **505** are provided in the pressure chamber **201**. However, only one deformation control unit **505** may be provided in the pressure chamber **201**. The deformation control units **505** protrude from the first surface **501** of the vibration plate **109** of the nozzle plate **100**.

[0070] The deformation control units **505** are now further described, with reference to a single deformation control unit **505**. The description is applicable to each of the plurality of deformation control units **505**, if more than one deformation control unit **505** is provided. The deformation control unit **505** is formed of silicon which is the same material as the pressure chamber structure **200**. However, the deformation control unit **505** may be formed of a different material from the pressure chamber structure **200**. In addition, the deformation control unit **505** may be formed out of a portion of the vibration plate **109**.

[0071] FIG. **4** is a cross-sectional view of a part of the ink jet head **10** taken along line F**4**-F**4** of FIG. **3**. As shown in FIG. **4**, the deformation control unit **505** is formed in an annular shape. The deformation control unit **505** is disposed coaxially with the nozzle **101**. In other words, the deformation control unit **505** surrounds the nozzle **101** so that the center of the deformation control unit **505** and the center of the nozzle **101** are substantially the same. However, the center of the deformation control unit **505** and the center of the nozzle **101** may deviate from each other.

[0072] The deformation control unit **505** is disposed at a position overlapping the actuator **102** on the nozzle plate **100**. In other words, the deformation control unit **505** is disposed inside a region D on the nozzle plate that is defined by an outer edge of the actuator **102**. An external diameter of the actuator **102** having an annular shape is, for example, 174 μm.

[0073] A distance between an inner edge of the deformation control unit **505** and an outer edge thereof is smaller than a distance between an inner edge of the actuator **102** and the outer edge thereof. In other words, an annular width of the deformation control unit **505** is smaller than an annular width of the actuator **102**. The annular width of the deformation control unit **505** is, for example, 10 μm to 30 μm. The annular width of the deformation control unit **505** is, for example, 10 μm to 100 μm.

[0074] Considering the plurality of deformation control units **505**, the deformation control unit **505** on the innermost side of the nozzle plate **100** is separated from the nozzle **101**. The plurality of deformation control units **505** are arranged at equal intervals. However, the innermost deformation control unit **505** may be adjacent to the nozzle **101**. Also, the deformation control units **505** may be arranged at different intervals.

[0075] The above-described inkjet printer **1** performs printing (i.e., image formation) as follows. Ink is supplied to the ink supply port **401** of the ink feed passage structure **400** from the ink tank **11**. The ink is supplied to the plurality of pressure chambers **201** via the plurality of ink apertures **301**. The ink supplied to the pressure chamber **201** is then supplied into the corresponding nozzle **101** and forms a meniscus in the nozzle **101**. The ink supplied from the ink supply port **401** is held with an appropriate negative pressure, so that the ink within the nozzle **101** is held without leaking from the nozzle **101**.

[0076] A printing instruction signal is input to the driving circuit, for example, by a user's operation. The driving circuit that received the printing instruction outputs the signal to the actuator **102** through the wiring electrode **108**. In other words, the driving circuit applies a voltage to the electrode portion **108***a* of the wiring electrode **108**. Thereby, an electric field is applied to the piezoelectric film **111** in the same direction as a polarization direction, and the actuator **102** expands and contracts in a direction perpendicular to the direction of the electric field.

[0077] The actuator **102** is sandwiched between the vibration plate **109** and the protective film **113**. Thus, when the actuator **102** extends in the direction perpendicular to the direction of the electric field, force for deforming in a concave shape with respect to the pressure chamber **201** side is applied to the vibration plate **109**. Furthermore, a force for deforming in a convex shape with respect to the pressure chamber **201** side is applied to the protective film **113**. When the actuator **102** contracts in the direction perpendicular to the direction of the electric field, a force for deforming in a convex shape with respect to the pressure chamber **201** side is applied to the vibration plate **109**. In addition, a force for deforming in a concave shape with respect to the pressure chamber **201** side is applied to the protective film **113**.

[0078] FIG. **5** is a cross-sectional view of a part of the ink jet head **10** in which the nozzle plate **100** is deformed. In FIG. **5**, the nozzle plate **100** and the actuator **102** are shown. In

addition, FIG. **5** shows only one deformation control unit **505**, although, as explained above, more than one may be used.

[0079] The polyimide film of the protective film **113** has a Young's modulus smaller than that of the vibration plate **109**. For this reason, the protective film **113** has a greater deformation amount with respect to the same force. When the actuator **102** extends in the direction perpendicular to the direction of the electric field, the nozzle plate **100** is deformed in a convex shape with respect to the pressure chamber **201** side, as shown in FIG. **5**. Thereby, the capacity of the pressure chamber **201** is reduced because the protective film **113** has a greater deformation amount in a convex shape with respect to the pressure chamber **201** side. Conversely, when the actuator **102** contracts in the direction perpendicular to the direction of the electric field, the nozzle plate **100** is deformed in a concave shape with respect to the pressure chamber **201** side. Thereby, the capacity of the pressure chamber **201** is increased because the protective film **113** has a greater deformation amount in a concave shape with respect to the pressure chamber **201** side. In this manner, the actuator **102** changes the capacity of the pressure chamber **201** by deforming the nozzle plate **100**.

[0080] When the volume of the pressure chamber **201** is increased or reduced by the deformation of the nozzle plate **100**, a pressure change occurs in the ink of the pressure chamber **201**. The ink supplied to the nozzles **101** is discharged by the pressure change. In FIG. **5**, the discharged ink droplets are shown as a dashed-two dotted line.

[0081] As a difference in the Young's modulus between the vibration plate **109** and the protective film **113** increases, a difference in deformation amount of the vibration plate **109** when the same voltage is applied to the actuator **102** increases. For this reason, as the difference in the Young's modulus between the vibration plate **109** and the protective film **113** increases, ink can be discharged at a lower voltage.

[0082] When a voltage is applied to the actuator **102** in a case where the vibration plate **109** and the protective film **113** have the same film thickness and Young's modulus, forces that cause the deformation by the same amount in the directly opposite directions are applied to the vibration plate **109** and the protective film **113**, and thus the vibration plate **109** is not deformed.

[0083] Meanwhile, as described above, a deformation amount of a plate is affected by not only the Young's modulus of a material but also a plate thickness. For this reason, when a difference occurs in the deformation amount between the vibration plate **109** and the protective film **113**, both the Young's modulus of each material and the film thicknesses of each material are considered. Even when the materials of the vibration plate **109** and the protective film **113** have the same Young's modulus, if there is a difference between the film thicknesses, ink can be discharged.

[0084] Next, an example of a method of manufacturing the ink jet head **10** will be described. First, the vibration plate **109** is formed in the pressure chamber structure **200** (which is formed from a silicon wafer) before the pressure chamber **201** is formed. The SiO_2 film for forming the vibration plate **109** is formed on the entirety of the mounting surface **200***a* of the pressure chamber structure **200** by using, for example, a CVD method. The SiO_2 film may also be formed by thermal oxidation. In addition, if the vibration plate **109** is formed of SiN, the vibration plate may be formed using a sputtering method.

[0085] Next, the vibration plate **109** is patterned to form the nozzles **101**. The patterning is performed by forming an etching mask on the vibration plate **109** and removing the unmasked portions of the vibration plate **109** through etching.

[0086] Next, the shared electrode **106** is formed on the second surface **502** of the vibration plate **109**. For example, Ti and Pt are sequentially deposited using a sputtering method. The shared electrode **106** may be formed by any of other manufacturing methods such as deposition or plating.

[0087] After the shared electrode **106** is formed, the plurality of electrode portions **106***a*, the wiring portion, and the two shared electrode terminal portions **105** are formed through patterning. The patterning is performed by forming an etching mask on an electrode film and removing the unmasked portions of electrode material through etching.

[0088] Since the nozzle **101** is formed at the center of the electrode portion **106***a* of the shared electrode **106**, a portion of the electrode portion **106***a* having no electrode film, concentric with the center of the electrode portion **106***a*, is formed. The shared electrode **106** is patterned, and thus the vibration plate **109** is exposed at positions other than at the electrode portion **106***a* of the shared electrode **106**, the wiring portion, and the shared electrode terminal portion **105**.

[0089] Next, the piezoelectric film **111** is formed on the shared electrode **106**. The piezoelectric film **111** is formed using, for example, an RF magnetron sputtering method. After the formation of the piezoelectric film, the piezoelectric film **111** is heated at a temperature of 500° C. for three hours in order to impart piezoelectricity to the piezoelectric film **111**. Thereby, the piezoelectric film **111** obtains a good piezoelectric performance. The piezoelectric film **111** may be formed using any of various manufacturing methods such as a CVD (chemical vapor deposition) method, a sol-gel method, an AD (aerosol deposition) method, or a hydrothermal synthesis method. The piezoelectric film **111** is patterned by etching.

[0090] Since the nozzle **101** is formed at the center of the piezoelectric film **111**, a portion having no piezoelectric film is formed which is concentric with the nozzle **101**. The vibration plate **109** is exposed in the portion not including the piezoelectric film **111**. The piezoelectric film **111** covers the electrode portion **106***a* of the shared electrode **106**.

[0091] Next, the insulating film **112** is formed on a part of the piezoelectric film **111** and apart of the shared electrode **106**. The insulating film **112** is formed using a CVD method capable of realizing a good insulation property through low-temperature film formation. The insulating film **112** is patterned after the film formation. In order to prevent defects from occurring due to patterning process variations, the insulating film **112** covers a part of the piezoelectric film **111**. The insulating film **112** covers the piezoelectric film **111** to the extent that a deformation amount of the piezoelectric film **111** is not obstructed.

[0092] Next, the wiring electrode **108** is formed on the vibration plate **109**, the piezoelectric film **111**, and the insulating film **112**. The wiring electrode **108** may be formed using a sputtering method. The wiring electrode **108** may also be formed using any of various manufacturing methods such as vacuum deposition or plating.

[0093] The electrode portion **108***a*, the wiring portion, and the wiring electrode terminal portion **107** are formed by patterning the formed wiring electrode **108**. The patterning is performed by forming an etching mask on an electrode film and removing unmasked portions of electrode material through etching.

[0094] Since the nozzle **101** is formed at the center of the electrode portion **108***a* of the wiring electrode **108**, a portion of the wiring electrode **108** having no electrode film is formed concentric with the electrode portion **108***a*. The electrode portion **108***a* of the wiring electrode **108** covers the piezoelectric film **111**.

[0095] Next, the protective film **113** is formed on the vibration plate **109**, the wiring electrode **108**, the shared electrode **106**, and the insulating film **112**. The protective film **113** is formed by depositing a solution containing a polyimide precursor through spin coating, and performing thermal polymerization and removal of the solution through baking. The protective film may be formed through spin coating, and thus a film having a smooth surface is formed. The protective film **113** may also be formed using any of various manufacturing methods such as CVD, vacuum deposition, plating, or spin on methods.

[0096] Next, patterning is performed to expose the shared electrode terminal portion **105** and the wiring electrode terminal portion **107** and to open the nozzles **101**. When non-photosensitive polyimide is used for the protective film **113**, patterning is performed by forming an etching mask on the non-photosensitive polyimide film and removing unmasked portions of the polyimide film through etching.

[0097] Next, a protective film cover tape is adhered onto the protective film **113**. The pressure chamber structure **200** to which the protective film cover tape is adhered is inverted vertically, and the plurality of pressure chambers **201** are formed in the pressure chamber structure **200**.

[0098] In detail, first, the protective film cover tape is attached onto the protective film **113**. For example, the protective film cover tape is a rear surface protection tape for chemical mechanical polishing (CMP) of a silicon wafer.

[0099] An etching mask is formed on the pressure chamber structure **200** which is a silicon wafer, and the unmasked portions of the silicon wafer are removed using a so-called vertical deep dry etching method exclusively for a silicon substrate, and thus the pressure chambers **201** are formed.

[0100] For example, a halftone mask is used as the etching mask. The halftone mask includes a transmissive portion and a semi-transmissive portion. The semi-transmissive portion is provided at a position corresponding to the deformation control unit **505**, and thus the pressure chambers **201** and the plurality of deformation control units **505** are formed by a single etching. In this manner, the deformation control units **505** are formed by etching the silicon wafer for forming the pressure chamber structure **200**.

[0101] SF6 gas used for the above-mentioned etching does not have an etching effect on the SiO_2 film and the SiN film of the vibration plate **109** and the polyimide film of the protective film **113**. For this reason, the progression of the dry etching of the silicon wafer for forming the pressure chambers **201** is stopped at the vibration plate **109**.

[0102] Meanwhile, the above-described etching may use any of various methods such as a wet etching method using a chemical solution or a dry etching method using plasma. The etching method and the etching conditions may be changed using a material such as an insulating film, an electrode film, or a piezoelectric film. After an etching process using a photosensitive resist film is finished, the remaining photosensitive resist film is removed using a solution.

[0103] In addition, the deformation control unit **505** may be formed using methods other than etching. For example, after the pressure chambers **201** are formed by etching, the deformation control units **505** may be formed using a sputtering method. In this case, the deformation control unit **505** may be formed of a material—for example, SiO_2—which is different from the material of the pressure chamber structure **200**.

[0104] Next, the separate plate **300** and the ink feed passage structure **400** are attached to the pressure chamber structure **200**. That is, the separate plate **300**, which is adhered to the ink feed passage structure **400**, is adhered to the pressure chamber structure by using an epoxy resin agent.

[0105] Next, a cover tape is attached to the protective film **113** so as to cover the shared electrode terminal portions **105** and the wiring electrode terminal portions **107**. The cover tape is formed of a resin, and can be easily desorbed from the protective film **113**. The cover tape prevents dust and the ink-repellent film **116** to be described below from adhering to the shared electrode terminal portion **105** and the wiring electrode terminal portion **107**.

[0106] Next, the ink-repellent film **116** is formed on the protective film **113**. The ink-repellent film **116** is formed on the protective film **113** by spin coating a liquid ink-repellent film material. During the spin coating process, positive pressure air is injected from the ink supply port **401**, so that the positive pressure air is discharged from the nozzles **101** connected to the ink supply passage **402**. In this state, when the liquid ink-repellent film material is applied, the ink-repellent film material is prevented from adhering to inner walls of the nozzles **101**.

[0107] After the ink-repellent film **116** is formed, the cover tape is peeled off from the protective film **113**. Thereby, the ink jet head **10** shown in FIG. **3** is formed. The ink jet head **10** is mounted inside the ink jet printer **1**. The driving circuit is then connected to the shared electrode terminal portions **105** and the wiring electrode terminal portions **107**.

[0108] According to the ink jet printer **1** of the first embodiment, the deformation control units **505** surrounding the nozzle **101** protrude from the first surface **501** of the vibration plate **109** of the nozzle plate **100**. The deformation control units **505** surround the nozzle, and thus there is a tendency for the deformation of the nozzle plate **100** through the actuator **102** to become uniform (i.e., symmetric) in the region surrounded by the deformation control units **505**.

[0109] Specifically, the nozzle plate **100** is deformed by the actuator **102** as shown in FIG. **5**. Non-uniform (i.e., asymmetric) deformation of the nozzle plate **100** occurs when, for example, a portion located on the right side of the nozzle **101** is deformed further than a portion located on the left side of the nozzle **101**. The non-uniformity of the deformation is reduced by the stiffness of the deformation control units **505** surrounding the nozzle **101**. Thereby, it is possible to prevent the deformation of the nozzle plate **100** from becoming non-uniform, and to prevent an ink discharge direction from becoming unstable.

[0110] The first surface **501** of the vibration plate **109** of the nozzle plate **100** applies pressure to the ink supplied to the pressure chambers **201**. The deformation control units **505** are provided in the vibration plate **109**, and thus non-uniform deformation of the nozzle plate **100** is prevented.

[0111] The deformation control units **505** are disposed inside the region D that is defined by the outer edge of the actuator **102**. Accordingly, deformation of the nozzle plate **100** is made substantially uniform due to the deformation control units **505**.

[0112] The annular width of the deformation control unit **505** is smaller than the annular width of the actuator **102**.

Thus, the deformation control unit **505** does not obstruct deformation of the nozzle plate **100** through the actuator **102**.

[0113] The center of the deformation control unit **505** is aligned with the center of the nozzle **101**. Thereby, the deformation of the nozzle plate **100** is uniform (i.e., symmetric) in a region centered around the nozzle **101**. This arrangement prevents ink discharge from becoming unstable.

[0114] However, the center of each of the plurality of deformation control units **505** may be different from the center of the nozzle **101**. In this case, the nozzle plate **100** is uniformly deformed by adjusting the position of each of the deformation control units **505**.

[0115] Next, a second embodiment will be described with reference to FIG. **6**. Components in the second embodiment having the same function as the ink jet printer **1** of the first embodiment are denoted by the same reference numerals. Further, the description of the component may be partially or totally omitted.

[0116] FIG. **6** is a cross-sectional view of a part of the ink jet head **10** according to the second embodiment. As shown in FIG. **6**, a plurality of slits **506** are provided in the deformation control units **505** of the second embodiment. In other words, the plurality of deformation control units **505** are arc-like ribs that are adjacent to each other, separated by the slits **506**.

[0117] The plurality of slits **506** are radially located around the nozzle **101**. In other words, the plurality of slits **506** are located from an inner edge the deformation control unit **505** to an outer edge thereof. The slits **506** of an outer deformation control unit **505** are arranged alternately with the slits **506** of a deformation control unit **505** located inside the outer deformation control unit **505**.

[0118] The depth of the slit **506** is equal to the thickness of the deformation control unit **505**. In other words, in a portion where the slit **506** is provided, the deformation control unit **505** is removed. Thus the first surface **501** of the vibration plate **109** is exposed at each slit **506**. However, the depth of the slit **506** is not limited thereto, and may be, for example, half the thickness of the deformation control unit **505**.

[0119] According to the ink jet printer **1** of the second embodiment, the slits **506** are provided in the deformation control unit **505**. Thereby, ink can pass through the slits **506**, and thus it is possible to prevent the ink from pooling inside the deformation control unit **505**.

[0120] Next, a third embodiment will be described with reference to FIG. **7**. FIG. **7** is a cross-sectional view of a part of the ink jet head **10** according to the third embodiment. As shown in FIG. **7**, the deformation control unit **505** of the third embodiment is formed in a spiral shape. Thereby, it is possible for the ink to flow to the nozzle **101**, and to prevent the ink from pooling inside the deformation control unit **505**.

[0121] Next, fourth and fifth embodiments will be described with reference to FIG. **8** and FIG. **9**. FIG. **8** is a cross-sectional view of a part of the ink jet head **10** according to the fourth embodiment. As shown in FIG. **8**, the pressure chamber **201** of the fourth embodiment is formed in a rectangular shape. The actuator **102** and the deformation control units **505** correspond to the pressure chamber **201**, and are also formed in a rectangular shape.

[0122] FIG. **9** is a cross-sectional view of a part of the ink jet head **10** according to the fifth embodiment. As shown in FIG. **9**, the pressure chamber **201** of the fifth embodiment is formed in a rhombic shape. The pressure chamber **201** is formed in a rhombic shape, and thus there is a tendency for the nozzles **101** to be arranged in a zigzag manner. The actuator **102** and the deformation control unit **505** correspond to the pressure chamber **201**, and are also formed in a rhombic shape.

[0123] In the fourth and fifth embodiments, the shapes of the actuator **102** and the deformation control unit **505** are similar to the shape of the pressure chamber **201**. Meanwhile, the shapes of the actuator **102** and the deformation control unit **505** may be flat or inclined with respect to the shape of the pressure chamber **201**.

[0124] The center of the deformation control unit **505** is aligned with the center of the nozzle **101**. In other words, the shape of the actuator **102** is formed so as to be point-symmetrical with respect to the center of the nozzle **101**.

[0125] As in the above-described embodiment, the deformation control unit **505** is not limited to an annular shape, and may have any of various shapes. Likewise, the shape of the deformation control unit **505** may be different from the shapes of the pressure chamber **201** and the actuator **102**.

[0126] While certain embodiments have been described, these embodiments have been presented by way of example only, and are not intended to limit the scope of the inventions. Indeed, the novel embodiments described herein may be embodied in a variety of other forms; furthermore, various omissions, substitutions and changes in the form of the embodiments described herein may be made without departing from the spirit of the inventions. The accompanying claims and their equivalents are intended to cover such forms or modifications as would fall within the scope and spirit of the inventions.

What is claimed is:

1. An ink jet head comprising:

a substrate including a mounting surface and a pressure chamber open to the mounting surface;

a nozzle plate including an inner surface fixed to the mounting surface and covering the pressure chamber, a nozzle open to the pressure chamber, and a piezoelectric element surrounding the nozzle and configured to deform to thereby change a volume of the pressure chamber; and

a deformation control unit disposed on and extending from the inner surface of the nozzle plate and surrounding the nozzle, the deformation control unit configured to cause deformation of the piezoelectric element to be substantially symmetric with respect to the nozzle.

2. The ink jet head according to claim **1**, wherein:

the deformation control unit is disposed on the inner surface of the nozzle plate within a region defined by an outer edge of the piezoelectric element.

3. The ink jet head according to claim **2**, wherein:

a distance between an inner edge of the deformation control unit and an outer edge of the deformation control unit is smaller than a distance between an inner edge of the piezoelectric element and an outer edge of the piezoelectric element.

4. The ink jet head according to claim **3**, wherein a center of the deformation control unit is aligned with a center of the nozzle.

5. The ink jet head according to claim **1**, wherein:

the deformation control unit includes at least one slit configured to permit ink to flow through the deformation control unit.

6. The ink jet head according to claim **1**, wherein:

the deformation control unit has a shape of one of a spiral, a rectangle and a rhombus.

7. The ink jet head according to claim 1, wherein:
the deformation control unit includes at least a first deformation control unit and a second deformation control unit disposed outside of the first deformation control unit.

8. An ink jet head comprising:
a pressure chamber formed in a substrate having a mounting surface, the pressure chamber being open to the mounting surface;
a nozzle plate including an inner surface fixed to the mounting surface and covering the pressure chamber, a nozzle open to the pressure chamber, and a piezoelectric element surrounding the nozzle and configured to deform to thereby change a volume of the pressure chamber;
a deformation control unit disposed on and extending from the inner surface of the nozzle plate and surrounding the nozzle, the deformation control unit configured to cause deformation of the piezoelectric element to be substantially symmetric with respect to the nozzle; and
a wiring electrode configured to supply a driving voltage to the piezoelectric element to thereby cause the piezoelectric element to deform.

9. The ink jet head according to claim 8, wherein:
the deformation control unit is disposed on the inner surface of the nozzle plate within a region defined by an outer edge of the piezoelectric element.

10. The ink jet head according to claim 9, wherein:
a distance between an inner edge of the deformation control unit and an outer edge of the deformation control unit is smaller than a distance between an inner edge of the piezoelectric element and an outer edge of the piezoelectric element.

11. The ink jet head according to claim 10, wherein a center of the deformation control unit is aligned with a center of the nozzle.

12. The ink jet head according to claim 8, wherein:
the deformation control unit includes at least one slit configured to permit ink to flow through the deformation control unit.

13. The ink jet head according to claim 8, wherein:
the deformation control unit has a shape of one of a spiral, a rectangle and a rhombus.

14. The ink jet head according to claim 8, wherein:
the deformation control unit includes at least a first deformation control unit and a second deformation control unit disposed outside of the first deformation control unit.

15. A method of forming an ink jet head comprising:
forming pressure chamber in a substrate having amounting surface and a pressure chamber open to the mounting surface;
fixing an inner surface of a nozzle plate to the mounting surface in a position covering the pressure chamber, the nozzle plate having a nozzle open to the pressure chamber and a piezoelectric element surrounding the nozzle and configured to deform to thereby change a volume of the pressure chamber; and
forming a deformation control unit on and extending from the inner surface of the nozzle plate and surrounding the nozzle, the deformation control unit configured to cause deformation of the piezoelectric element to be substantially symmetric with respect to the nozzle.

16. The method according to claim 15, wherein:
the deformation control unit is formed on the inner surface of the nozzle plate within a region defined by an outer edge of the piezoelectric element.

17. The method according to claim 16, wherein:
the deformation control unit is formed so that a distance between an inner edge of the deformation control unit and an outer edge of the deformation control unit is smaller than a distance between an inner edge of the piezoelectric element and an outer edge of the piezoelectric element.

18. The method according to claim 17, wherein:
the deformation control unit is formed so that a center of the deformation control unit is aligned with a center of the nozzle.

19. The method according to claim 15, wherein:
forming the deformation control unit includes forming at least one slit in the deformation control unit to permit ink to flow through the deformation control unit.

20. The method according to claim 15, wherein:
forming the deformation control unit includes forming at least a first deformation control unit and forming a second deformation control unit outside of the first deformation control unit.

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